




SPECIFICATION SHEET

SPECIFICATION SHEET NO.	P0319-SMAFES2J00S260
DATE	March 19, 2022
REVISION	A0
DESCRIPTION	<p>SMD Super Fast Recovery Rectifier, SMAF series, ES2JF Type, 2 Pads</p> <p>Reverse Voltage 600V Max. Forward Current 2.0A Max.</p> <p>Operating Temp. Range -50°C ~+150°C</p> <p>Package in Tape/Reel, 3000pcs/7" Reel</p> <p>RoHS/RoHS III compliant</p>
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	MDD ES2JF
PART CODE	SMAFES2J00S260

VENDOR APPROVE			
Issued/Checked/Approved			
DATE: March 19, 2022			

CUSTOMER APPROVE	
DATE:	

3/21/2022

SMD SUPER FAST RECOVERY RECTIFIER SMAF SERIES



MAIN FEATURE

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Low reverse leakage
- Built-in strain relief
- High forward surge current capability
- High temperature soldering guaranteed: 250°C/ 10 seconds at terminals
- Glass passivated chip junction

APPLICATION

- For SMD application

RFQ

[Request For Quotation](#)

PART CODE GUIDE

SMAF	ES2J00	S	260
1	2	3	4

- 1) **SMAF**: SMD Super Fast Recovery Rectifier, SMAF series code
- 2) **ES2J00**: Type code for ES2JF
- 3) **S**: Package code, Tape/reel, 3000pcs/7" reel.
- 4) **260**: Specification code for Forward Current 2.0A Max. Reverse Voltage 600V Max.

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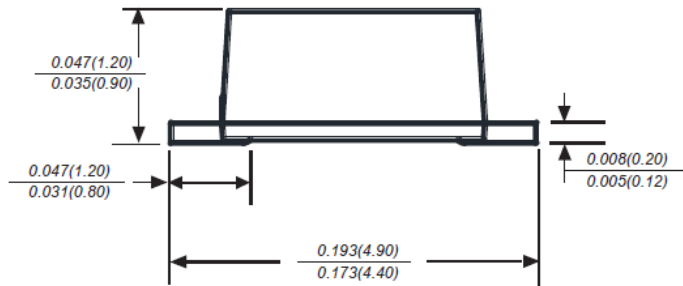
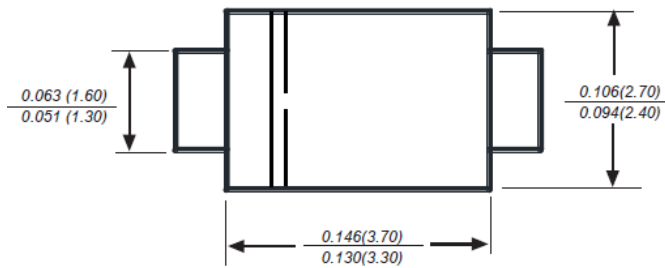
DIMENSION (Unit: Inch/mm)

Image for reference

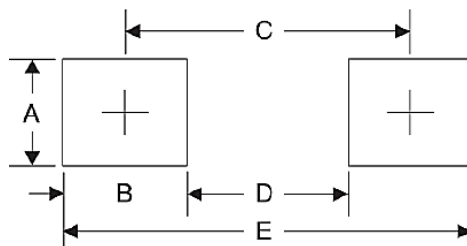


Marking: ES2JF

SMAF



Recommend Pad Layout



Symbol	Unit (Inch)	Unit (mm)
A	0.071	1.80
B	0.063	1.60
C	0.150	3.80
D	0.087	2.21
E	0.213	5.40

SMD SUPER FAST RECOVERY RECTIFIER SMAF SERIES
MECHANICAL DATA

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC SMAF molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Polarity symbol marking on case	Any	0.0020 Ounce, 0.0622 grams

MAX. RATING & CHARACTERISTICS

Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
Repetitive peak reverse voltage	V _{RRM}			600	Volts
RMS voltage	V _{RMS}			420	Volts
DC blocking voltage	V _{DC}			600	Volts
Average forward output rectified current at TL= 125°C	I _{AV}			2.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}		50		A
Instantaneous forward voltage at 2.0A	V _F			1.70	Volts
DC reverse current at rated DC blocking voltage	I _R	TA=25°C		5.0	μA
		TA=125°C		50	μA
Reverse recovery Time (Note 2)	t _{rr}			35	ns
Junction capacitance (NOTE 3)	C _J		60		pF
Thermal resistance (Note 4)	R _{QJA}		40		°C/W
Operating junction temperature range	T _J	-50		+150	°C
Storage temperature range	T _{STG}	-50		+150	°C

Note

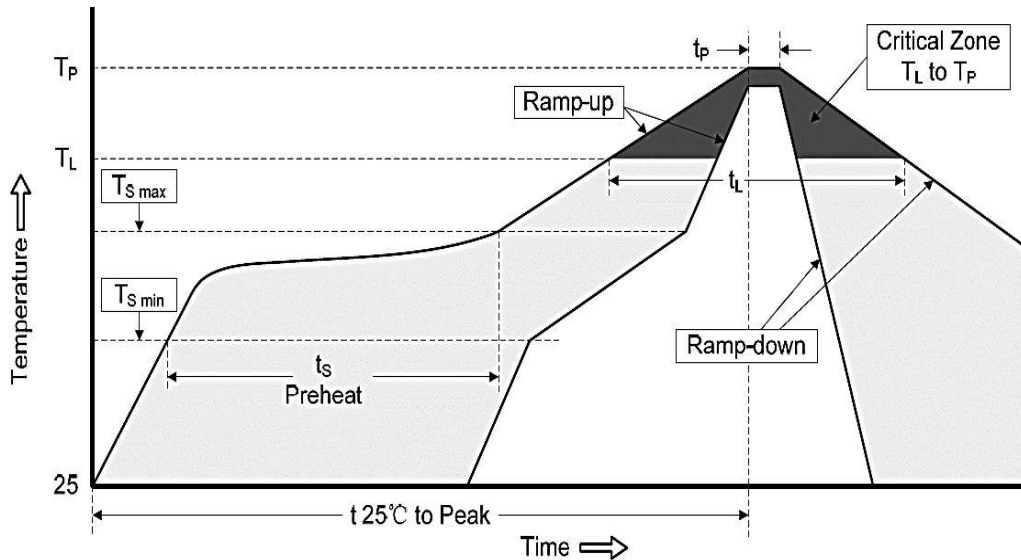
- Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
- Reverse recovery condition IF=0.5A,IR=1.0A,Irr=0.25A
- Measured at 1.0MHz and applied reverse voltage of 4.0Voltage
- P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas.

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RELIABILITY

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

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SUGGESTED REFLOW PROFILE (For Reference Only)



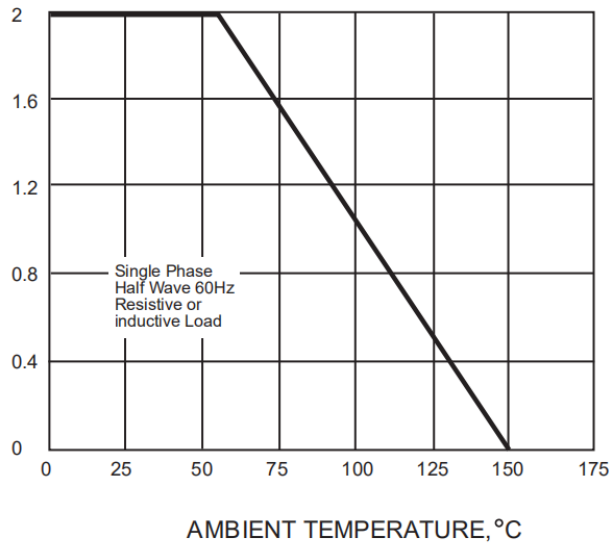
Profile Feature		Pb-Free Assembly
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 180 seconds
Time maintained above	Temperature (TL)	217°C
	Time (tL)	60 ~ 150 seconds
Peak/Classification Temperature (Tp)		250 °C
Time within 5°C of actual Peak Temperature (tp)		3 ~ 10 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

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RATINGS AND CHARACTERISTIC CURVES (For Reference Only)

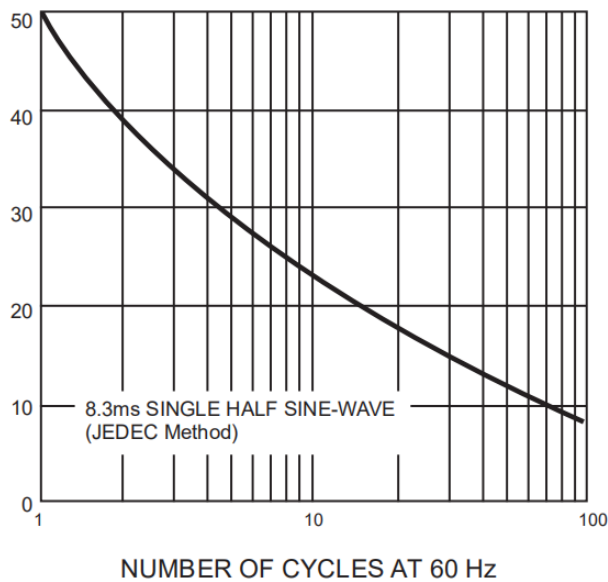
AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



PEAK FORWARD SURGE CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



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RATINGS AND CHARACTERISTIC CURVES (For Reference Only)

FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

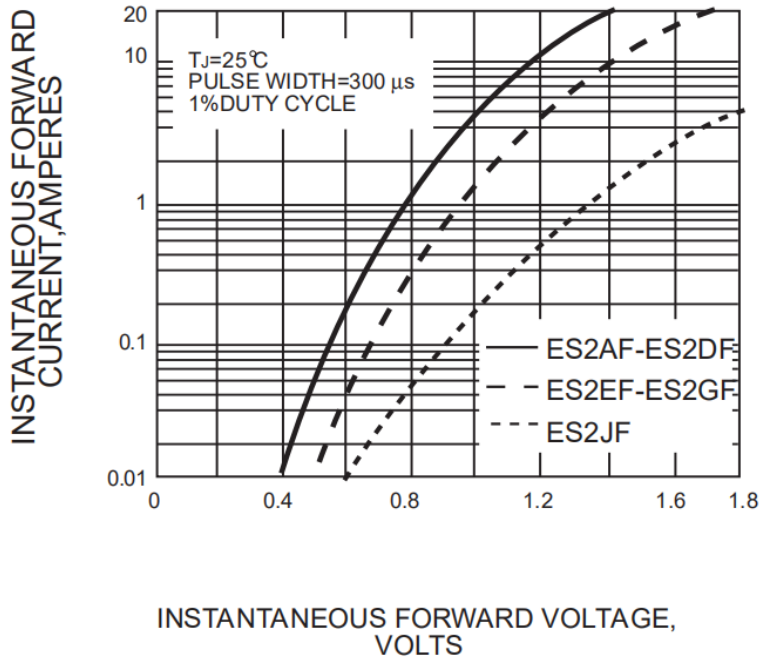
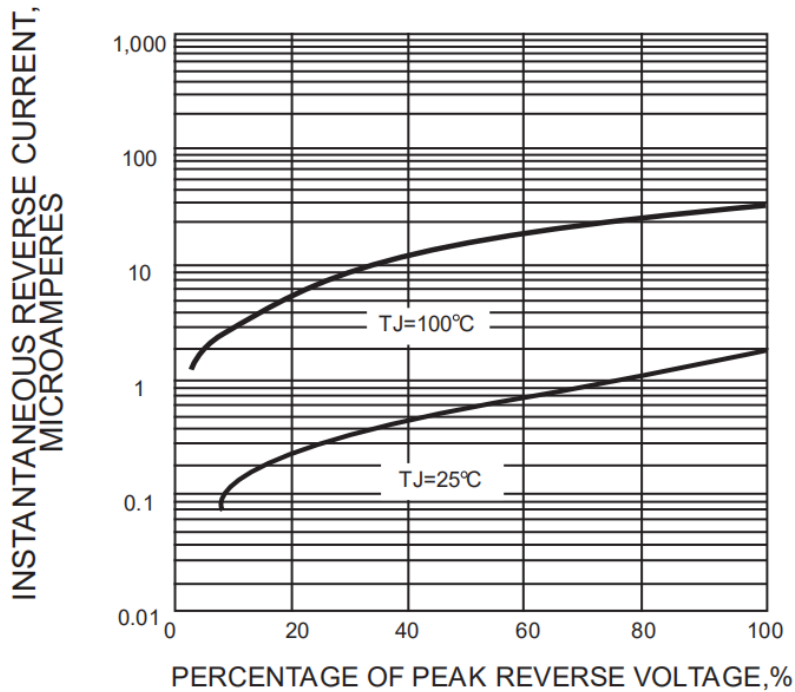


FIG. 4-TYPICAL REVERSE CHARACTERISTICS



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RATINGS AND CHARACTERISTIC CURVES (For Reference Only)

FIG. 5-TYPICAL JUNCTION CAPACITANCE

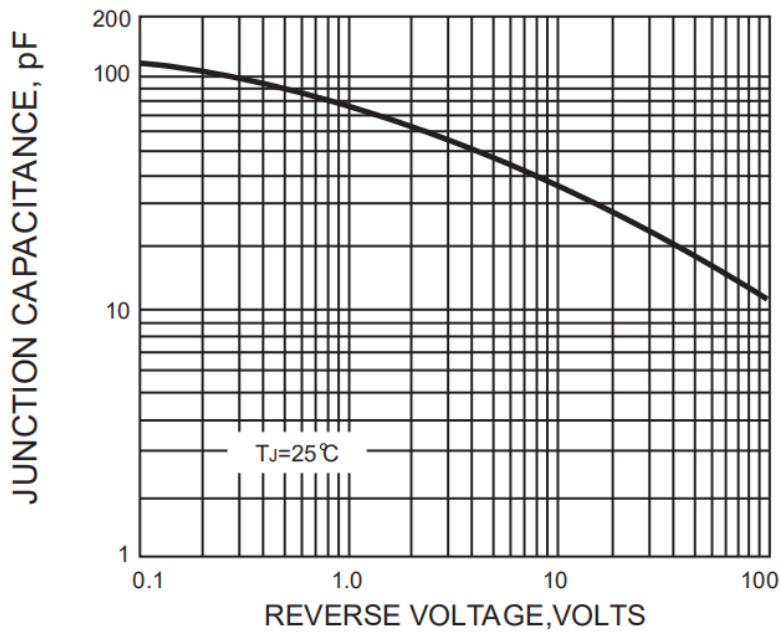
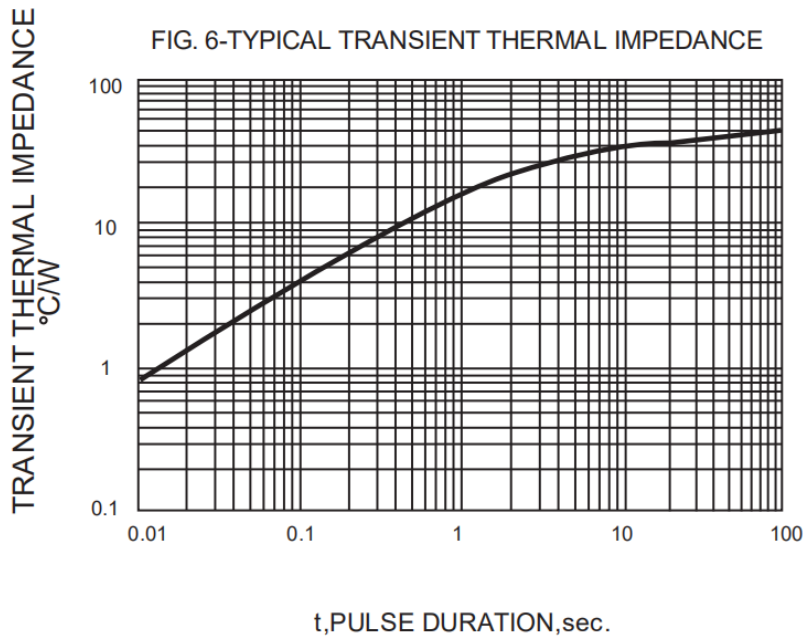


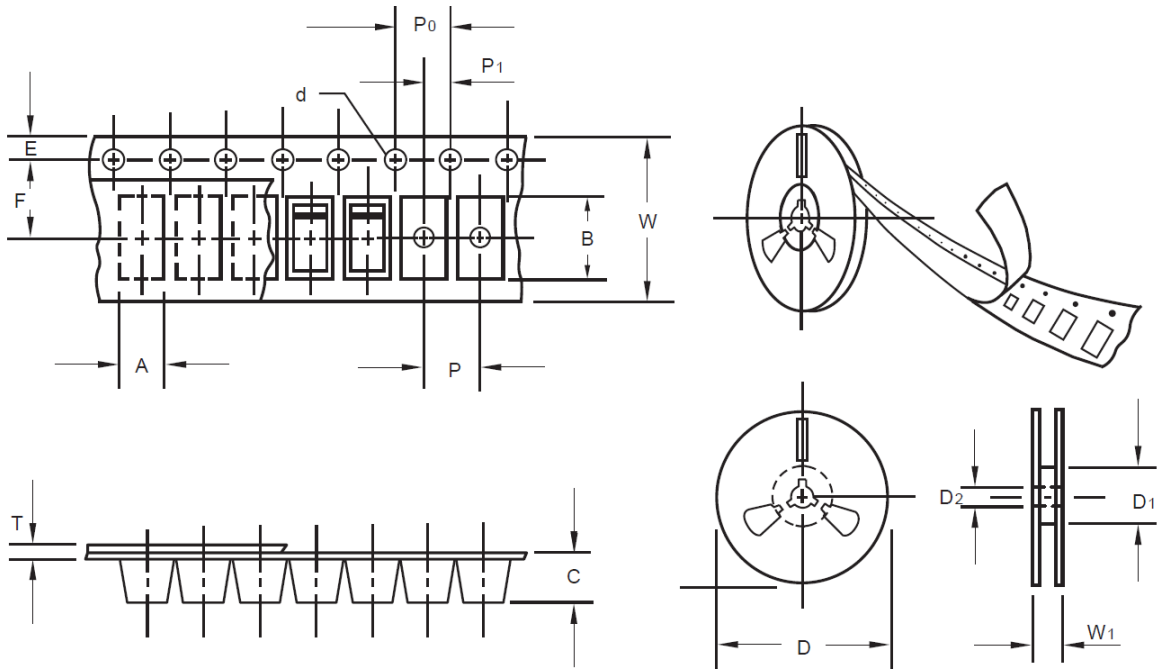
FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



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TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and specifications.



Item	Symbol	Tolerance	SMAF
Carrier width	A	0.1	2.80
Carrier Length	B	0.1	4.75
Carrier Depth	C	0.1	1.42
Sprocket hole	d	0.05	1.50
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	Min.	54.40
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.05
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.30
Tape width	W	0.3	8.00
Reel width	W1	1.0	12.30

SMD SUPER FAST RECOVERY RECTIFIER SMAF SERIES

SPQ PACKAGE for Reference

Item	Unit	Value
Case Code		SMAF
Reel Size	Inch	7"
Reel Size	mm	178
Tape Space	mm	/
SPQ /Reel	pcs	3000
Weigh /SPQ	LBS	2.0
Weigh /SPQ	KGs	-
Qty. Per Box	pcs	6,000

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